

Internally Matched Power GaAs FETs (X, Ku-Band)

Features

- High power
 - $P_{1dB} = 36.5$ dBm at 14.5 GHz to 15.0 GHz
- High gain
 - $G_{1dB} = 5.5$ dB at 14.5 GHz to 15.0 GHz
- Broad Band Internally Matched
- Hermetically sealed package

RF Performance Specifications ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Condition	Unit	Min.	Typ.	Max
Output Power at 1dB Compression Point	P_{1dB}	$V_{DS} = 9V$ $f = 14.5 \sim 15.0$ GHz	dBm	35.5	36.5	–
Power Gain at 1dB Compression Point	G_{1dB}		dB	4.5	5.5	–
Drain Current	I_{DS}		A	–	1.7	2.2
Power Added Efficiency	η_{add}		%	–	21	–
Channel-Temperature Rise	ΔT_{ch}	$V_{DS} \times I_{DS} \times R_{th(c-c)}$	$^\circ\text{C}$	–	–	70

Electrical Characteristics ($T_a = 25^\circ\text{C}$)

Characteristic	Symbol	Condition	Unit	Min.	Typ.	Max
Trans-conductance	gm	$V_{DS}=3V$ $I_{DS}=2.0$ A	mS	–	1200	–
Pinch-off Voltage	V_{GSoff}	$V_{DS}=3V$ $I_{DS}=60$ mA	V	-2	-3.5	-5
Saturated Drain Current	I_{DSS}	$V_{DS}=3V$ $V_{GS}=0V$	A	–	4.0	5.2
Gate to Source Breakdown Voltage	V_{GSO}	$I_{GS}=-60$ μA	V	-5	–	–
Thermal Resistance	$R_{th(c-c)}$	Channel to case	$^\circ\text{C/W}$	–	2.9	3.5

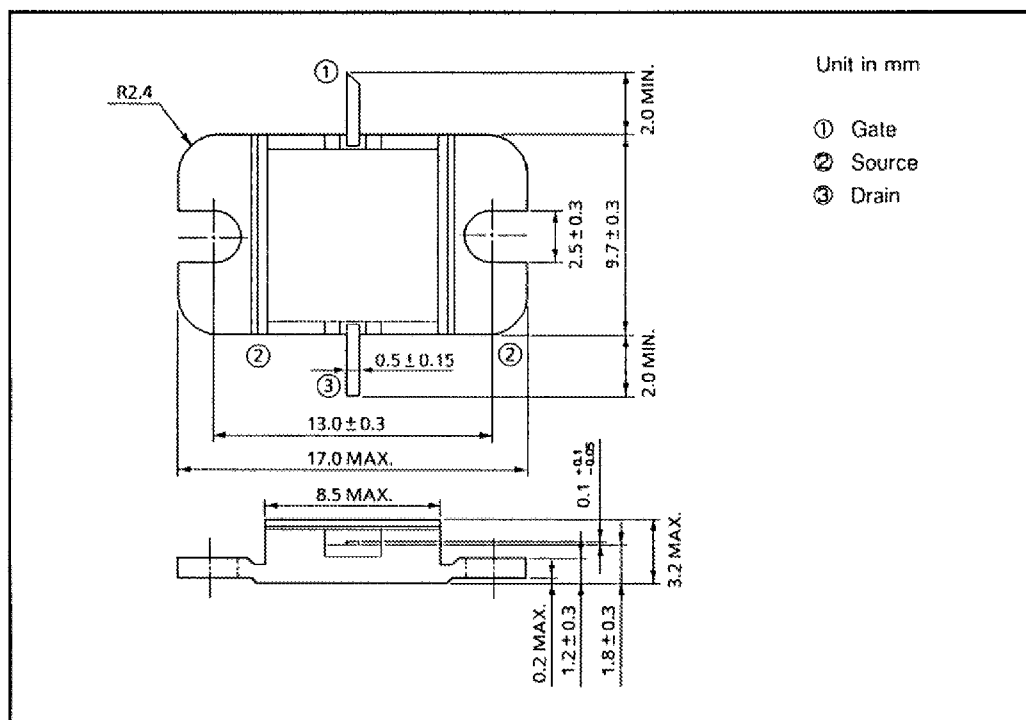
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Absolute Maximum Ratings (T_a = 25° C)

Characteristic	Symbol	Unit	Rating
Drain Source Voltage	V _{DS}	V	15
Gate Source Voltage	V _{GS}	V	-5
Drain Current	I _{DS}	A	5.2
Total Power Dissipation (T _c = 25°C)	P _T	W	30
Channel Temperature	T _{ch}	°C	175
Storage Temperature	T _{stg}	°C	-65~175

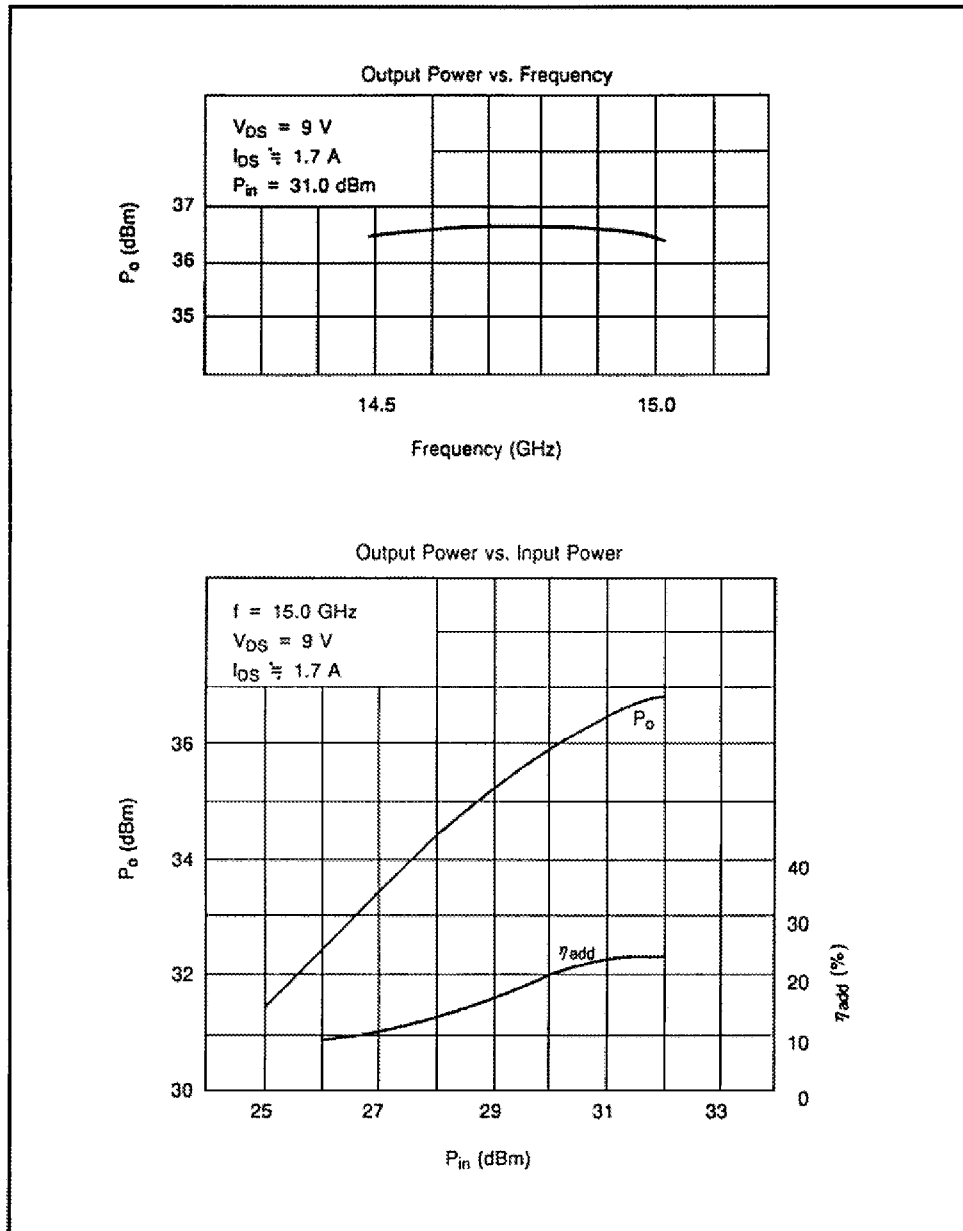
Package Outline (2-9D1B)



Handling Precautions for Packaged Type

Soldering iron should be grounded and the operating time should not exceed 10 seconds at 260°C.

RF Performances



Power Dissipation vs. Case Temperature

